

PCA9532

16-bit I²C-bus LED dimmer

Rev. 04 — 17 March 2009

Product data sheet

1. General description

The PCA9532 is a 16-bit I²C-bus and SMBus I/O expander optimized for dimming LEDs in 256 discrete steps for Red/Green/Blue (RGB) color mixing and back light applications.

The PCA9532 contains an internal oscillator with two user programmable blink rates and duty cycles coupled to the output PWM. The LED brightness is controlled by setting the blink rate high enough (> 100 Hz) that the blinking cannot be seen and then using the duty cycle to vary the amount of time the LED is on and thus the average current through the LED.

The initial setup sequence programs the two blink rates/duty cycles for each individual PWM. From then on, only one command from the bus master is required to turn individual LEDs ON, OFF, BLINK RATE 1 or BLINK RATE 2. Based on the programmed frequency and duty cycle, BLINK RATE 1 and BLINK RATE 2 will cause the LEDs to appear at a different brightness or blink at periods up to 1.69 second. The open-drain outputs directly drive the LEDs with maximum output sink current of 25 mA per bit and 200 mA per package (100 mA per octal).

To blink LEDs at periods greater than 1.69 second the bus master (MCU, MPU, DSP, chip set, etc.) must send repeated commands to turn the LED on and off as is currently done when using normal I/O expanders like the NXP Semiconductors PCF8575 or PCA9555. Any bits not used for controlling the LEDs can be used for General Purpose parallel Input/Output (GPIO) expansion, which provides a simple solution when additional I/O is needed for ACPI power switches, sensors, push-buttons, alarm monitoring, fans, etc.

The active LOW hardware reset pin (RESET) and Power-On Reset (POR) initializes the registers to their default state, all zeroes, causing the bits to be set HIGH (LED off).

Three hardware address pins on the PCA9532 allow eight devices to operate on the same bus.

2. Features

- 16 LED drivers (on, off, flashing at a programmable rate)
- Two selectable, fully programmable blink rates (frequency and duty cycle) between 0.591 Hz and 152 Hz (1.69 second and 6.58 milliseconds)
- 256 brightness steps
- Input/outputs not used as LED drivers can be used as regular GPIOs
- Internal oscillator requires no external components
- I²C-bus interface logic compatible with SMBus
- Internal power-on reset



16-bit I2C-bus LED dimmer

- Noise filter on SCL/SDA inputs
- Active LOW reset input
- 16 open-drain outputs directly drive LEDs to 25 mA
- Controlled edge rates to minimize ground bounce
- No glitch on power-up
- Supports hot insertion
- Low standby current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 0 Hz to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 150 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Packages offered: SO24, TSSOP24, HVQFN24

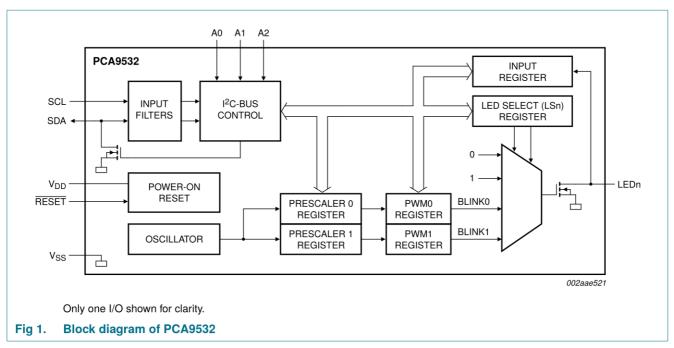
3. Ordering information

Table 1. Ordering information

 $T_{amb} = -40 \, ^{\circ}C$ to $+85 \, ^{\circ}C$.

Type number	Topside mark	Package	Package					
		Name	Description	Version				
PCA9532D	PCA9532D	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1				
PCA9532PW	PCA9532	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1				
PCA9532BS	9532	HVQFN24	plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body 4 \times 4 \times 0.85 mm	SOT616-1				

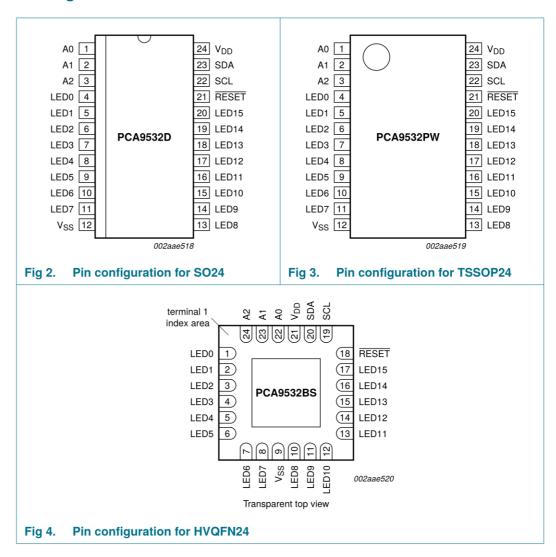
4. Block diagram



16-bit I2C-bus LED dimmer

5. Pinning information

5.1 Pinning



16-bit I²C-bus LED dimmer

5.2 Pin description

Table 2. Pin description

Symbol	Pin		Description
	SO24, TSSOP24	HVQFN24	
A0	1	22	address input 0
A1	2	23	address input 1
A2	3	24	address input 2
LED0	4	1	LED driver 0
LED1	5	2	LED driver 1
LED2	6	3	LED driver 2
LED3	7	4	LED driver 3
LED4	8	5	LED driver 4
LED5	9	6	LED driver 5
LED6	10	7	LED driver 6
LED7	11	8	LED driver 7
V_{SS}	12	9 <mark>[1]</mark>	supply ground
LED8	13	10	LED driver 8
LED9	14	11	LED driver 9
LED10	15	12	LED driver 10
LED11	16	13	LED driver 11
LED12	17	14	LED driver 12
LED13	18	15	LED driver 13
LED14	19	16	LED driver 14
LED15	20	17	LED driver 15
RESET	21	18	reset input (active LOW)
SCL	22	19	serial clock line
SDA	23	20	serial data line
V_{DD}	24	21	supply voltage

^[1] HVQFN24 package die supply ground is connected to both V_{SS} pin and exposed center pad. V_{SS} pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the PCB in the thermal pad region.

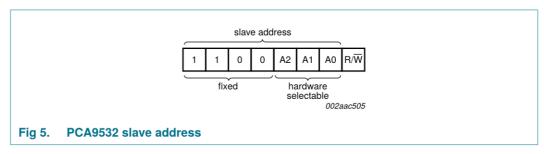
16-bit I2C-bus LED dimmer

6. Functional description

Refer to Figure 1 "Block diagram of PCA9532".

6.1 Device address

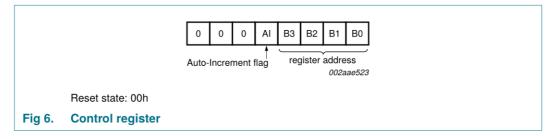
Following a START condition, the bus master must output the address of the slave it is accessing. The address of the PCA9532 is shown in Figure 5. To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.



The last bit of the address byte defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

6.2 Control register

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9532, which will be stored in the Control register.



The lowest 4 bits are used as a pointer to determine which register will be accessed.

If the Auto-Increment (AI) flag is set, the four low order bits of the Control register are automatically incremented after a read or write. This allows the user to program the registers sequentially. The contents of these bits will rollover to '0000' after the last register is accessed.

When Auto-Increment flag is set (AI = 1) and a read sequence is initiated, the sequence must start by reading a register different from the INPUT0 register (B3 B2 B1 B0 \neq 0 0 0 0).

Only the 4 least significant bits are affected by the AI flag. Unused bits must be programmed with zeroes.

16-bit I2C-bus LED dimmer

6.2.1 Control register definition

Table 3. Register summary

В3	B2	B1	B0	Symbol	Access	Description
БЗ	DZ	ы	ь	Syllibol	Access	Description
0	0	0	0	INPUT0	read only	input register 0
0	0	0	1	INPUT1	read only	input register 1
0	0	1	0	PSC0	read/write	frequency prescaler 0
0	0	1	1	PWM0	read/write	PWM register 0
0	1	0	0	PSC1	read/write	frequency prescaler 1
0	1	0	1	PWM1	read/write	PWM register 1
0	1	1	0	LS0	read/write	LED0 to LED3 selector
0	1	1	1	LS1	read/write	LED4 to LED7 selector
1	0	0	0	LS2	read/write	LED8 to LED11 selector
1	0	0	1	LS3	read/write	LED12 to LED15 selector

6.3 Register descriptions

6.3.1 INPUT0 - Input register 0

The INPUT0 register reflects the state of the device pins (inputs 0 to 7). Writes to this register will be acknowledged but will have no effect.

Table 4. INPUT0 - Input register 0 description

Bit	7	6	5	4	3	2	1	0
Symbol	LED7	LED6	LED5	LED4	LED3	LED2	LED1	LED0
Default	X	Χ	Χ	Χ	Χ	Χ	Χ	Χ

Remark: The default value 'X' is determined by the externally applied logic level (normally logic 1) when used for directly driving LED with pull-up to V_{DD}.

6.3.2 INPUT1 - Input register 1

The INPUT1 register reflects the state of the device pins (inputs 8 to 15). Writes to this register will be acknowledged but will have no effect.

Table 5. INPUT1 - Input register 1 description

Bit	7	6	5	4	3	2	1	0
Symbol	LED15	LED14	LED13	LED12	LED11	LED10	LED9	LED8
Default	X	X	X	X	X	X	Х	Χ

Remark: The default value 'X' is determined by the externally applied logic level (normally logic 1) when used for directly driving LED with pull-up to V_{DD} .

16-bit I2C-bus LED dimmer

6.3.3 PCS0 - Frequency Prescaler 0

PSC0 is used to program the period of the PWM output.

The period of BLINK0 = (PSC0 + 1) / 152.

Table 6. PSC0 - Frequency Prescaler 0 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PSC0[7]	PSC0[6]	PSC0[5]	PSC0[4]	PSC0[3]	PSC0[2]	PSC0[1]	PSC0[0]
Default	0	0	0	0	0	0	0	0

6.3.4 PWM0 - Pulse Width Modulation 0

The PWM0 register determines the duty cycle of BLINK0. The outputs are LOW (LED on) when the count is less than the value in PWM0 and HIGH (LED off) when it is greater. If PWM0 is programmed with 00h, then the PWM0 output is always HIGH (LED off).

The duty cycle of BLINK0 = PWM0 / 256.

Table 7. PWM0 - Pulse Width Modulation 0 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PWM0 [7]	PWM0 [6]	PWM0 [5]	PWM0 [4]	PWM0 [3]	PWM0 [2]	PWM0 [1]	PWM0 [0]
Default	1	0	0	0	0	0	0	0

6.3.5 PCS1 - Frequency Prescaler 1

PSC1 is used to program the period of the PWM output.

The period of BLINK1 = (PSC1 + 1) / 152.

Table 8. PSC1 - Frequency Prescaler 1 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PSC1[7]	PSC1[6]	PSC1[5]	PSC1[4]	PSC1[3]	PSC1[2]	PSC1[1]	PSC1[0]
Default	0	0	0	0	0	0	0	0

6.3.6 PWM1 - Pulse Width Modulation 1

The PWM1 register determines the duty cycle of BLINK1. The outputs are LOW (LED on) when the count is less than the value in PWM1 and HIGH (LED off) when it is greater. If PWM1 is programmed with 00h, then the PWM1 output is always HIGH (LED off).

The duty cycle of BLINK1 = PWM1 / 256.

Table 9. PWM1 - Pulse Width Modulation 1 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PWM1 [7]	PWM1 [6]	PWM1 [5]	PWM1 [4]	PWM1 [3]	PWM1 [2]	PWM1 [1]	PWM1 [0]
Default	1	0	0	0	0	0	0	0

16-bit I²C-bus LED dimmer

6.3.7 LS0 to LS3 - LED selector registers

The LSn LED selector registers determine the source of the LED data.

00 = output is set high-impedance (LED off; default)

01 = output is set LOW (LED on)

10 = output blinks at PWM0 rate

11 = output blinks at PWM1 rate

Table 10. LS0 to LS3 - LED selector registers bit description

Legend: * default value.

Register	Bit	Value	Description
LS0 - LED0	to LED3 s	selector	
LS0	7:6	00*	LED3 selected
	5:4	00*	LED2 selected
	3:2	00*	LED1 selected
	1:0	00*	LED0 selected
LS1 - LED4	to LED7	selector	
LS1	7:6	00*	LED7 selected
	5:4	00*	LED6 selected
	3:2	00*	LED5 selected
	1:0	00*	LED4 selected
LS2 - LED8	to LED11	selector	
LS2	7:6	00*	LED11 selected
	5:4	00*	LED10 selected
	3:2	00*	LED9 selected
	1:0	00*	LED8 selected
LS3 - LED12	2 to LED1	5 selector	
LS3	7:6	00*	LED15 selected
	5:4	00*	LED14 selected
	3:2	00*	LED13 selected
	1:0	00*	LED12 selected

16-bit I2C-bus LED dimmer

6.4 Pins used as GPIOs

LEDn pins not used to control LEDs can be used as General Purpose I/Os (GPIOs).

For use as input, set LEDn to high-impedance (00) and then read the pin state via the INPUT0 or INPUT1 register.

For use as output, connect external pull-up resistor to the pin and size it according to the DC recommended operating characteristics. LEDn output pin is HIGH when the output is programmed as high-impedance, and LOW when the output is programmed LOW through the 'LED selector' register. The output can be pulse-width controlled when PWM0 or PWM1 are used.

6.5 Power-on reset

When power is applied to V_{DD} , an internal Power-On Reset (POR) holds the PCA9532 in a reset condition until V_{DD} has reached V_{POR} . At that point, the reset condition is released and the PCA9532 registers are initialized to their default states, all the outputs in the OFF state. Thereafter, V_{DD} must be lowered below 0.2 V to reset the device.

6.6 External RESET

A reset can be accomplished by holding the \overline{RESET} pin LOW for a minimum of $t_{w(rst)}$. The PCA9532 registers and I²C-bus state machine will be held in their default states until the \overline{RESET} input is once again HIGH.

This input requires a pull-up resistor to V_{DD} if no active connection is used.

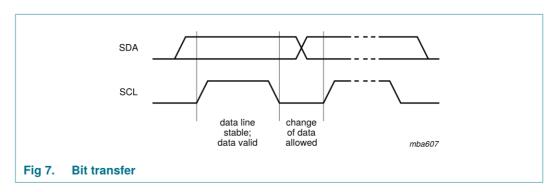
16-bit I2C-bus LED dimmer

7. Characteristics of the I²C-bus

The I²C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

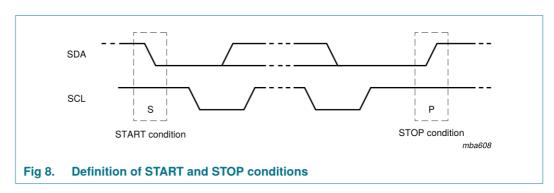
7.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 7).



7.1.1 START and STOP conditions

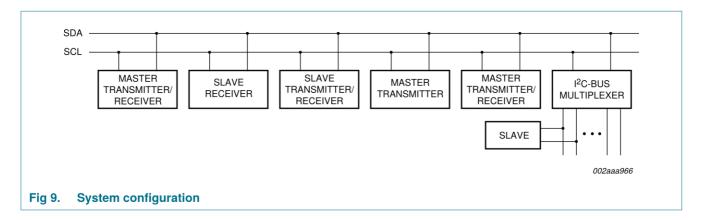
Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see Figure 8).



7.2 System configuration

A device generating a message is a 'transmitter'; a device receiving is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves' (see <u>Figure 9</u>).

16-bit I²C-bus LED dimmer

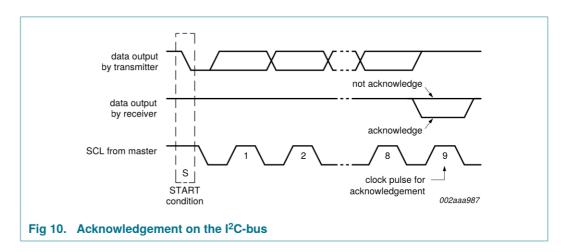


7.3 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter, whereas the master generates an extra acknowledge related clock pulse.

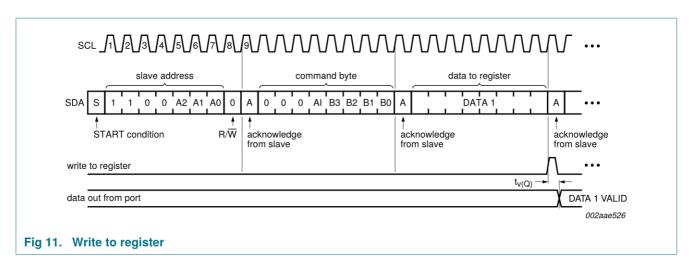
A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse; set-up and hold times must be taken into account.

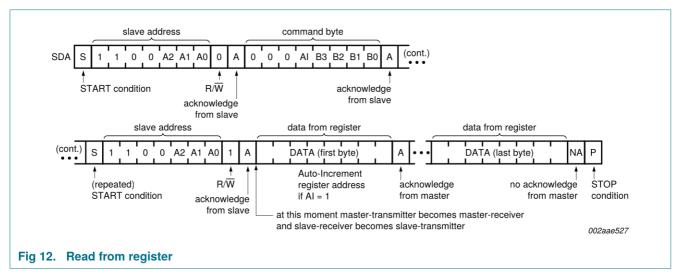
A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

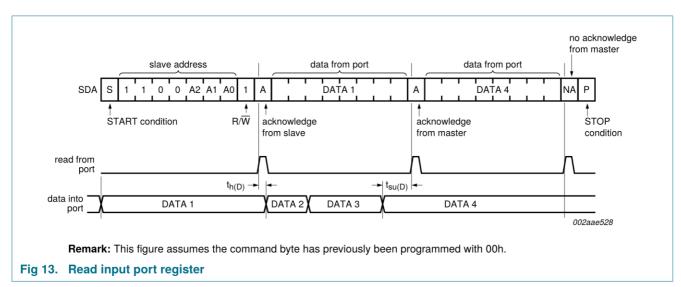


16-bit I2C-bus LED dimmer

7.4 Bus transactions

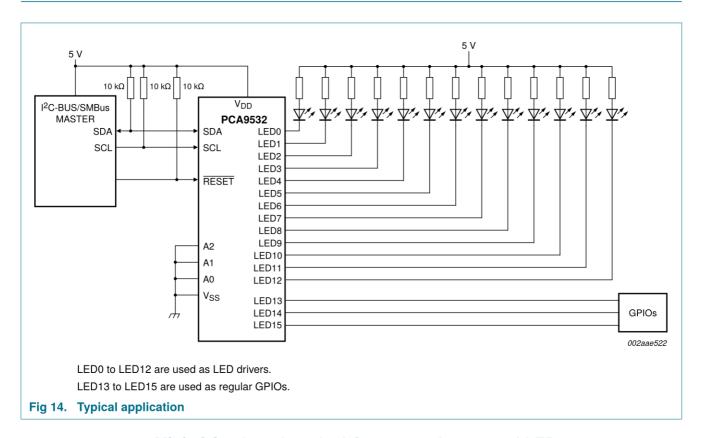






16-bit I2C-bus LED dimmer

8. Application design-in information

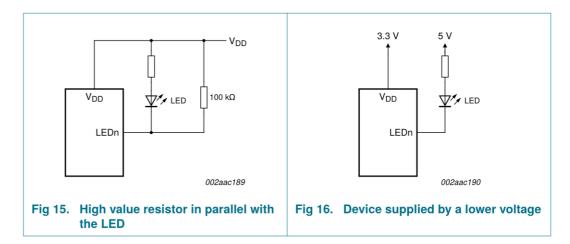


8.1 Minimizing I_{DD} when the I/Os are used to control LEDs

When the I/Os are used to control LEDs, they are normally connected to V_{DD} through a resistor as shown in <u>Figure 14</u>. Since the LED acts as a diode, when the LED is off the I/O V_I is about 1.2 V less than V_{DD} . The supply current, I_{DD} , increases as V_I becomes lower than V_{DD} and is specified as ΔI_{DD} in <u>Table 13</u> "Static characteristics".

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{DD} when the LED is off. Figure 15 shows a high value resistor in parallel with the LED. Figure 16 shows V_{DD} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_{I} at or above V_{DD} and prevents additional supply current consumption when the LED is off.

16-bit I²C-bus LED dimmer



8.2 Programming example

The following example will show how to set LED0 to LED3 on. It will then set LED4 and LED5 to blink at 1 Hz at a 50 % duty cycle. LED6 and LED7 will be set to be dimmed at 25 % of their maximum brightness (duty cycle = 25 %). LED8 to LED15 will be set to off.

Table 11. Programming PCA9532

Program sequence	I ² C-bus
START	S
PCA9532 address with A0 to A2 = LOW	C0h
PSC0 subaddress + Auto-Increment	12h
Set prescaler PSC0 to achieve a period of 1 second:	97h
$Blink\ period = 1 = \frac{PSC0 + 1}{152}$	
PSC0 = 151	
Set PWM0 duty cycle to 50 %:	80h
$\frac{PWM0}{256} = 0.5$	
PWM0 = 128	
Set prescaler PCS1 to dim at maximum frequency:	00h
$Blink\ period = max$	
PSC1 = 0	
Set PWM1 output duty cycle to 25 %:	40h
$\frac{PWM1}{256} = 0.25$	
PWM1 = 64	
Set LED0 to LED3 on	55h
Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1	FAh
Set LED8 to LED11 off	00h
Set LED12 to LED15 off	00h
STOP	Р

16-bit I²C-bus LED dimmer

9. Limiting values

Table 12. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+6.0	V
$V_{I/O}$	voltage on an input/output pin		V_{SS} -0.5	5.5	V
$I_{O(LEDn)}$	output current on pin LEDn		-	±2 5	mA
I_{SS}	ground supply current		-	200	mA
P _{tot}	total power dissipation		-	400	mW
T_{stg}	storage temperature		-6 5	+150	°C
T_{amb}	ambient temperature	operating	-4 0	+85	°C

16-bit I²C-bus LED dimmer

10. Static characteristics

Table 13. Static characteristics

 V_{DD} = 2.3 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

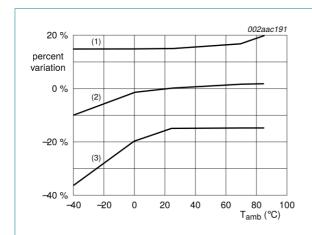
Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
Supplies							
V_{DD}	supply voltage			2.3	-	5.5	V
I _{DD}	supply current	operating mode; V_{DD} = 5.5 V; no load; V_{I} = V_{DD} or V_{SS} ; f_{SCL} = 100 kHz		-	350	550	μΑ
I _{stb}	standby current	Standby mode; V_{DD} = 5.5 V; no load; V_{I} = V_{DD} or V_{SS} ; f_{SCL} = 0 kHz		-	2.1	5.0	μΑ
ΔI _{DD}	additional quiescent supply current	Standby mode; V_{DD} = 5.5 V; every LED I/O at V_I = 4.3 V; f_{SCL} = 0 kHz		-	-	2	mA
V_{POR}	power-on reset voltage	V_{DD} = 3.3 V; no load; V_{I} = V_{DD} or V_{SS}	[2]	-	1.7	2.2	V
Input SC	L; input/output SDA						
V_{IL}	LOW-level input voltage			-0.5	-	$+0.3V_{DD}$	V
V_{IH}	HIGH-level input voltage			$0.7V_{DD}$	-	5.5	V
l _{OL}	LOW-level output current	V _{OL} = 0.4 V		3	6.5	-	mA
ار	leakage current	$V_{I} = V_{DD} = V_{SS}$		-1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$		-	4.4	5	pF
I/Os							
V_{IL}	LOW-level input voltage			-0.5	-	+0.8	V
V_{IH}	HIGH-level input voltage			2.0	-	5.5	V
I _{OL}	LOW-level output current	$V_{OL} = 0.4 V$					
		$V_{DD} = 2.3 \text{ V}$	[3]	9	-	-	mA
		$V_{DD} = 3.0 \text{ V}$	[3]	12	-	-	mΑ
		V _{DD} = 5.0 V	[3]	15	-	-	mA
		$V_{OL} = 0.7 V$					
		$V_{DD} = 2.3 \text{ V}$	[3]	15	-	-	mΑ
		$V_{DD} = 3.0 \text{ V}$	[3]	20	-	-	mA
		V _{DD} = 5.0 V	[3]	25	-	-	mA
ILI	input leakage current	V_{DD} = 3.6 V; V_I = 0 V or V_{DD}		-1	-	+1	μΑ
C _{io}	input/output capacitance			-	2.6	5	pF
Select in	puts A0, A1, A2; RESET						
V _{IL}	LOW-level input voltage			-0.5	-	+0.8	V
V _{IH}	HIGH-level input voltage			2.0	-	5.5	V
ILI	input leakage current			-1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$		-	2.3	5	pF

^[1] Typical limits at V_{DD} = 3.3 V, T_{amb} = 25 °C.

^[2] V_{DD} must be lowered to 0.2 V in order to reset part.

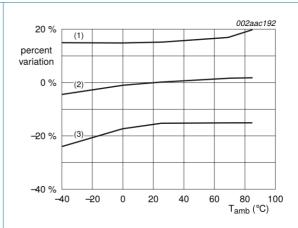
^[3] Each I/O must be externally limited to a maximum of 25 mA and each octal ([LED0 to LED7] and [LED8 to LED15]) must be limited to a maximum current of 100 mA for a device total of 200 mA.

16-bit I²C-bus LED dimmer



- (1) maximum
- (2) average
- (3) minimum

Fig 17. Typical frequency variation over process at $V_{DD} = 2.3 \ V$ to 3.0 V



- (1) maximum
- (2) average
- (3) minimum

Fig 18. Typical frequency variation over process at $V_{DD} = 3.0 \ V$ to 5.5 V

16-bit I²C-bus LED dimmer

11. Dynamic characteristics

Table 14. Dynamic characteristics

Symbol	Parameter	Conditions		Standard-mode I ² C-bus		Fast-mode l ²	Fast-mode I ² C-bus		
				Min	Max	Min	Max		
f _{SCL}	SCL clock frequency			0	100	0	400	kHz	
t _{BUF}	bus free time between a STOP and START condition			4.7	-	1.3	-	μs	
t _{HD;STA}	hold time (repeated) START condition			4.0	-	0.6	-	μs	
t _{SU;STA}	set-up time for a repeated START condition			4.7	-	0.6	-	μs	
t _{SU;STO}	set-up time for STOP condition			4.0	-	0.6	-	μs	
t _{HD;DAT}	data hold time			0	-	0	-	ns	
t _{VD;ACK}	data valid acknowledge time		[1]	-	600	-	600	ns	
t _{VD;DAT}	data valid time	LOW-level	[2]	-	600	-	600	ns	
		HIGH-level	[2]	-	1500	-	600	ns	
t _{SU;DAT}	data set-up time			250	-	100	-	ns	
t _{LOW}	LOW period of the SCL clock			4.7	-	1.3	-	μs	
t _{HIGH}	HIGH period of the SCL clock			4.0	-	0.6	-	μs	
t _r	rise time of both SDA and SCL signals			-	1000	$20 + 0.1C_{b}$	300	ns	
t _f	fall time of both SDA and SCL signals			-	300	$20 + 0.1C_{b}^{[3]}$	300	ns	
t _{SP}	pulse width of spikes that must be suppressed by the input filter			-	50	-	50	ns	
Port timin	g								
$t_{v(Q)}$	data output valid time			-	200	-	200	ns	
t _{su(D)}	data input set-up time			100	-	100	-	ns	
t _{h(D)}	data input hold time			1	-	1	-	μs	
Reset									
t _{w(rst)}	reset pulse width			10	-	10	-	ns	
t _{rec(rst)}	reset recovery time			0	-	0	-	ns	
t _{rst}	reset time		[4][5]	400	-	400	-	ns	

^[1] $t_{VD;ACK}$ = time for Acknowledgement signal from SCL LOW to SDA (out) LOW.

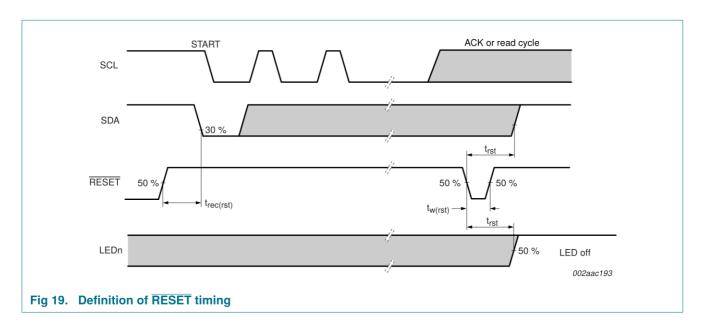
^[2] $t_{VD;DAT}$ = minimum time for SDA data output to be valid following SCL LOW.

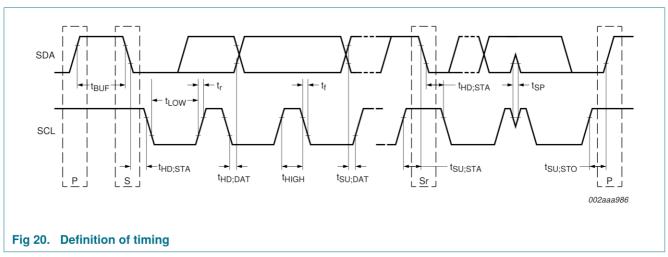
^[3] $C_b = \text{total capacitance of one bus line in pF.}$

^[4] Resetting the device while actively communicating on the bus may cause glitches or errant STOP conditions.

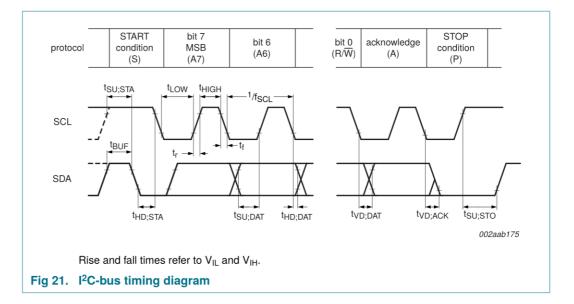
^[5] Upon reset, the full delay will be the sum of t_{rst} and the RC time constant of the SDA bus.

16-bit I²C-bus LED dimmer

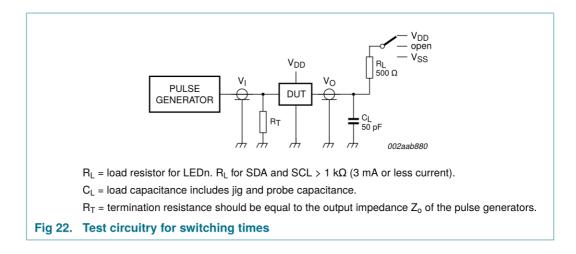




16-bit I²C-bus LED dimmer



12. Test information

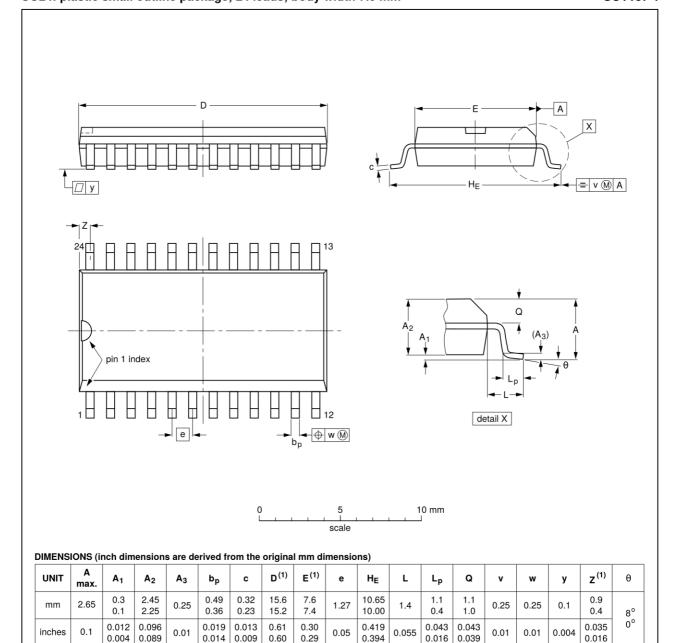


16-bit I²C-bus LED dimmer

13. Package outline

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

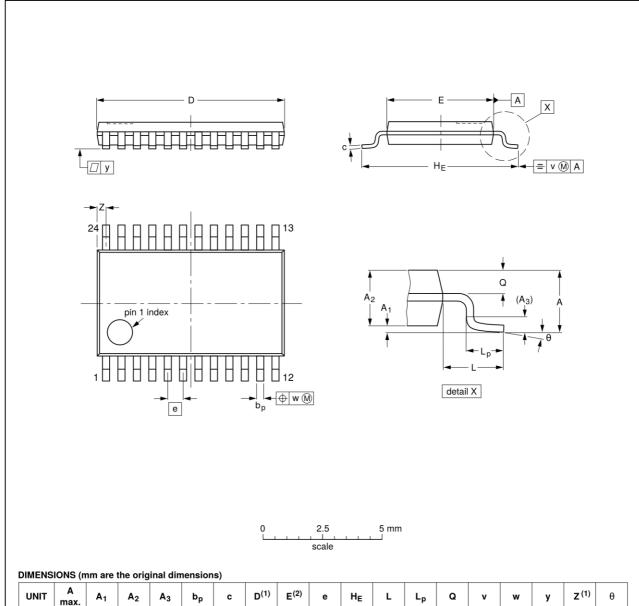
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT137-1	075E05	MS-013			-99-12-27 03-02-19	

Fig 23. Package outline SOT137-1 (SO24)

16-bit I²C-bus LED dimmer

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



						-,												
UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	REFER	EUROPEAN	ISSUE DATE		
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	MO-153				-99-12-27 03-02-19
	IEC	IEC JEDEC		IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION

Fig 24. Package outline SOT355-1 (TSSOP24)

16-bit I²C-bus LED dimmer

HVQFN24: plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body 4 x 4 x 0.85 mm

SOT616-1

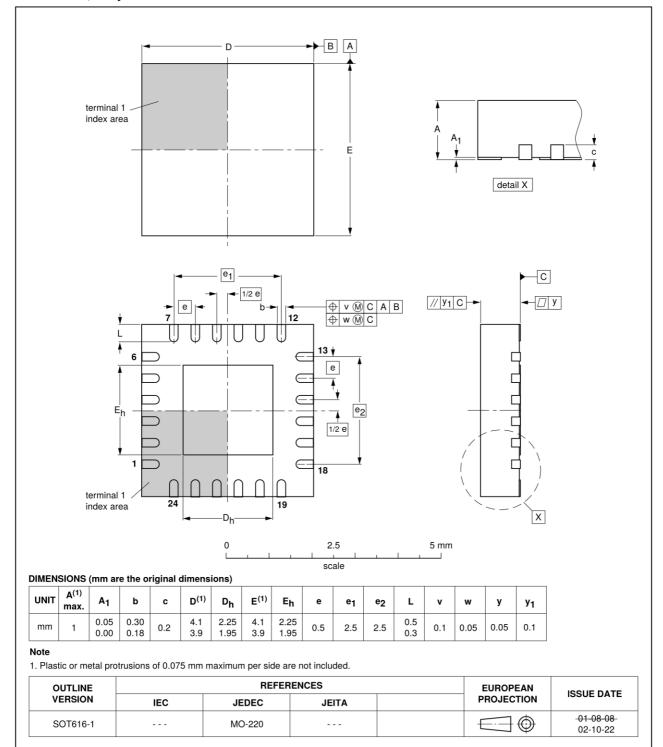


Fig 25. Package outline SOT616-1 (HVQFN24)

16-bit I²C-bus LED dimmer

14. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling ensure that the appropriate precautions are taken as described in *JESD625-A* or equivalent standards.

15. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

15.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

15.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- · Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- · Package placement
- · Inspection and repair
- Lead-free soldering versus SnPb soldering

15.3 Wave soldering

Key characteristics in wave soldering are:

16-bit I2C-bus LED dimmer

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

15.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 26</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 15 and 16

Table 15. SnPb eutectic process (from J-STD-020C)

Package thickness (mm)	Package reflow temperature (°C)				
	Volume (mm³)				
	< 350	≥350			
< 2.5	235	220			
≥2.5	220	220			

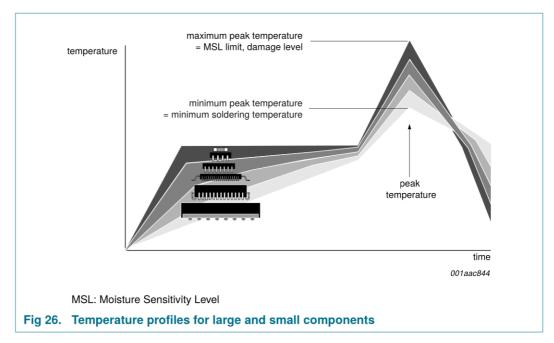
Table 16. Lead-free process (from J-STD-020C)

Package thickness (mm)	Package reflow temperature (°C)						
	Volume (mm³)						
	< 350	350 to 2000	> 2000				
< 1.6	260	260	260				
1.6 to 2.5	260	250	245				
> 2.5	250	245	245				

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 26.

16-bit I²C-bus LED dimmer



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

16. Abbreviations

Table 17. Abbreviations

Acronym	Description
ACPI	Advanced Configuration and Power Interface
CDM	Charged Device Model
DSP	Digital Signal Processor
DUT	Device Under Test
ESD	ElectroStatic Discharge
GPIO	General Purpose Input/Output
HBM	Human Body Model
I ² C-bus	Inter-Integrated Circuit bus
LED	Light Emitting Diode
MCU	MicroController Unit
MM	Machine Model
MPU	MicroProcessor Unit
POR	Power-On Reset
RC	Resistor-Capacitor network
SMBus	System Management Bus

16-bit I²C-bus LED dimmer

17. Revision history

Table 18. Revision history

Table 18.	Revisio	n history						
Documen	t ID	Release date	Data sheet status	Change notice	Supersedes			
PCA9532_	_4	20090317	Product data sheet	-	PCA9532_3			
Modification	ons:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
		 Legal texts have been adapted to the new company name where appropriate. 						
		 Section 5.1 " TSSOP24 (F 	Pinning": replaced (old) Figu igure 3)	re 1 with separate drawings	for SO24 (<u>Figure 2</u>) and			
		• Table 2 "Pin	description": added Table no	te [1] and its reference at H	VQFN24 pin 9, V _{SS}			
		 Section 6.2 " 	Control register":					
		 2nd parag 	raph: changed from "The lov	vest 3 bits are" to "The lov	vest 4 bits are"			
			raph: changed from " by re ifferent from INPUT0"	ading a register different fro	m '0'" to " by reading a			
		 Section 6.6 " 	External RESET", 1st paragr	aph, 1 st sentence: changed	symbol from "t _W " to "t _{w(rst)} "			
		 Figure 11 "W 	<u>/rite to register"</u> : symbol char	nged from " t_{pv} " to " $t_{v(Q)}$ "				
		 Figure 13 "R 	ead input port register":					
		 Symbol c 	hanged from " t_{ph} " to " $t_{h(D)}$ "					
		 Symbol changed from "t_{ps}" to "t_{su(D)}" 						
		 <u>Table 12 "Limiting values"</u>: changed symbol/parameter from "I_{I/O}, DC output current on an I/O" to "I_{O(LEDn)}, output current on pin LEDn" 						
		<u>Table 13 "Static characteristics"</u> :						
			<i>r</i> e line below table title: 2 nd s eading "Typ"	entence is moved to Table r	note [1], with its reference at			
		 \(\Delta \left \DD \) para current" 	meter changed from "additio	nal standby current" to "add	litional quiescent supply			
		Sub-section	on "I/Os": symbol changed fi	om "l _L " to "l _{Ll} "				
		 Table 14 "Dy 	namic characteristics":					
		Symbol/p	arameter changed from "t _{PV} , arameter changed from "t _{PS} , arameter changed from "t _{PH} ,	Input data set-up time" to "	$t_{su(D)}$, data input set-up time"			
		 Symbol c 	hanged from "t _W " to "t _{w(rst)} "					
		 Symbol c 	hanged from "t _{REC} " to "t _{rec(rst}	"				
		Symbol/p	arameter changed from "t _{RES}	$_{ m SET}$, Time to reset" to " $t_{ m rst}$, re	eset time"			
		 Figure 19 "D 	efinition of RESET timing":					
		 Symbol c 	hanged from " t_{REC} " to " $t_{rec(rst)}$,"				
		Symbol c	hanged from "t _{RESET} " to "t _{rst} "					
		 Symbol c 	hanged from "t _W " to "t _{w(rst)} "					
		 Symbol c 	hanged from " t_{RESET} " to " t_{rst} "					
		 Updated har 	dling information					

PCA9532_3	20041001	Product data sheet	-	PCA9532_2
PCA9532_2 (9397 750 11459)	20030502	Product data	ECN 853-2398 29860 dated 24 Apr 2003	PCA9532_1
PCA9532_1 (9397 750 10874)	20030226	Product data	ECN 853-2398 29297 dated 12 Dec 2002	-

· Added soldering information

16-bit I2C-bus LED dimmer

18. Legal information

18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

18.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

18.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

18.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

I²C-bus — logo is a trademark of NXP B.V.

19. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

PCA9532 NXP Semiconductors

19 20

16-bit I²C-bus LED dimmer

20. Contents

1	General description
2	Features
3	Ordering information 2
4	Block diagram 2
5	Pinning information 3
5.1	Pinning
5.2	Pin description 4
6	Functional description 5
6.1	Device address 5
6.2	Control register 5
6.2.1	Control register definition 6
6.3	Register descriptions 6
6.3.1	INPUT0 - Input register 0 6
6.3.2 6.3.3	INPUT1 - Input register 1 6 PCS0 - Frequency Prescaler 0
6.3.4	PWM0 - Pulse Width Modulation 0
6.3.5	PCS1 - Frequency Prescaler 1
6.3.6	PWM1 - Pulse Width Modulation 1
6.3.7	LS0 to LS3 - LED selector registers 8
6.4	Pins used as GPIOs 9
6.5	Power-on_reset
6.6	External RESET
7	Characteristics of the I^2 C-bus 10
7.1	Bit transfer
7.1.1	START and STOP conditions
7.2 7.3	System configuration
7.3 7.4	Acknowledge
8	Application design-in information 13
8.1	Minimizing I _{DD} when the I/Os are used to
0.1	control LEDs
8.2	Programming example
9	Limiting values
10	Static characteristics
11	Dynamic characteristics
12	Test information
13	Package outline
14	Handling information
15	
15.1	Soldering of SMD packages
15.1	Wave and reflow soldering
15.3	Wave soldering
15.4	Reflow soldering
16	Abbreviations
17	Revision history

18	Legal information	28
18.1	Data sheet status	28
18.2	Definitions	28
18.3	Disclaimers	28
18.4	Trademarks	28
19	Contact information	28
20	Contonto	20

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.





© NXP B.V. 2009. All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 17 March 2009 Document identifier: PCA9532_4